

VRRM	IF (TC≤125℃)	QC	
650V	12A	23nC	

Applications:

- Switch Mode Power Supplies
- Power Factor Correction
- Motor drive, PV Inverter, Wind Power Station

Features:

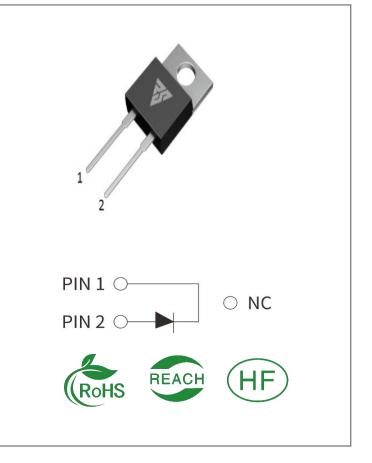
- Zero Reverse Recovery Current
- Zero Forward Recovery Voltage
- Positive Temperature Coefficient on VF
- Temperature-independent Switching
- 175°C Operating Junction Temperature

Benefits:

- Replace Bipolar with Unipolar Device
- Reduction of Heat Sink Size
- Parallel Devices Without Thermal Runaway
- Essentially No Switching Losses

Ordering Information

Part Number	er Package Marking		Packing	Qty.	
RSS06065B	TO-220-2 内绝缘	RSS06065B	Tube	50 PCS	





Maximum Ratings (TJ= 25°C unless otherwise specified)

Symbol	Parameter	Value	Unit	Test Conditions	Note
VRRM	Repetitive Peak Reverse Voltage	650	V	TC = 25℃	
VRSM	Surge Peak Reverse Voltage	650	V	TC = 25℃	
VR	DC Blocking Voltage	650	V	TC = 25℃	
		21		TC ≤ 25℃	
IF	Forward Current	12	Α	TC ≤ 125℃	Fig.3
		6		TC ≤ 150℃	
				TC = 25°C, tp = 10ms,	
IFSM	Non-Repetitive Forward Surge	50	•	Half Sine Wave	
	Current	42	A	TC = 110°C, tp = 10ms,	
				Half Sine Wave	
	Repetitive Peak Forward Surge	25		TC = 25℃, tp = 10ms,	
IFRM	Current	35	A	Half Sine Wave	
Ptot	Power Dissipation	70	W	TC = 25℃	Fig.4
тс	Maximum Case Temperature	150	°C		
TITCTO	Operating Junction and Storage	-55	°C		
TJ,TSTG	Temperature	to175			

Electrical Characteristics (TJ= 25°C unless otherwise specified)

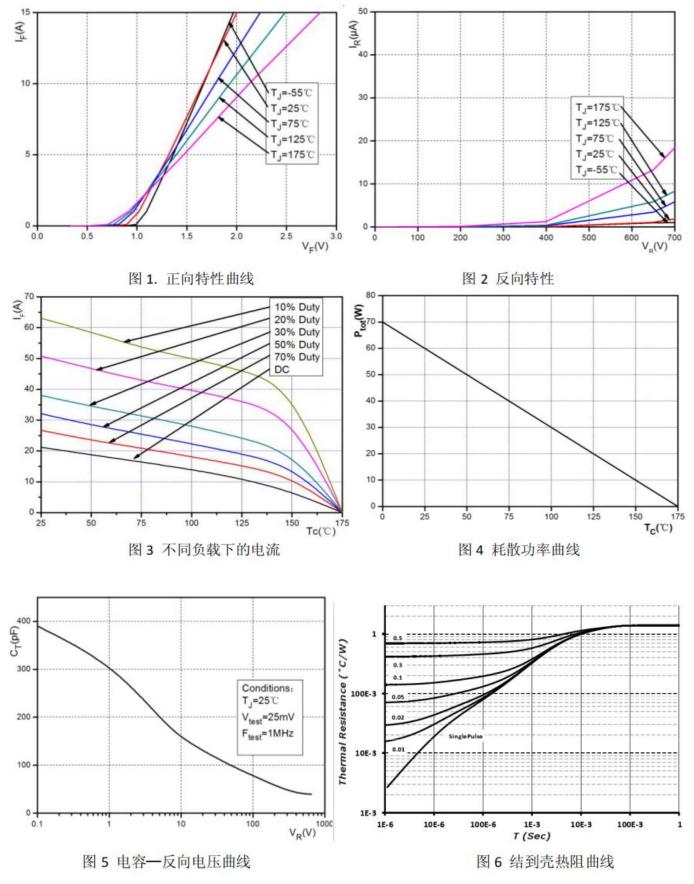
Symbol	Parameter	Тур.	Max.	Unit	Test Conditions	Note	
VF Forward Voltage	Forward Voltago	1.42	1.6	V	IF = 6A, TJ = 25℃	Fig 1	
	Forward Voltage	1.59	1.8	v	IF = 6A, TJ = 175℃	Fig.1	
IR		2	30		VR = 650V, TJ = 25℃	Fig.2	
IR Reverse Current	Reverse Current	15	120	μA	VR = 650V, TJ = 175℃		
		423			VR = 1V, TJ = 25°C, f = 1MHz		
С	Total Capacitance	44	/	рF	VR = 200V, TJ = 25 °C, f = 1MHz	Fig.5	
		37			VR = 400V, TJ = 25°C, f = 1MHz		
00	Total Capacitive	23	1	~C	$M_{\rm P} = 400M$		
QC	Charge			nC	VR =400V,		

Thermal Characteristics (TJ= 25° C unless otherwise specified)

Symbol	Parameter	Тур.	Unit	Note
RθJC	Thermal Resistance from Junction to Case	2.3	°C/W	Fig.6

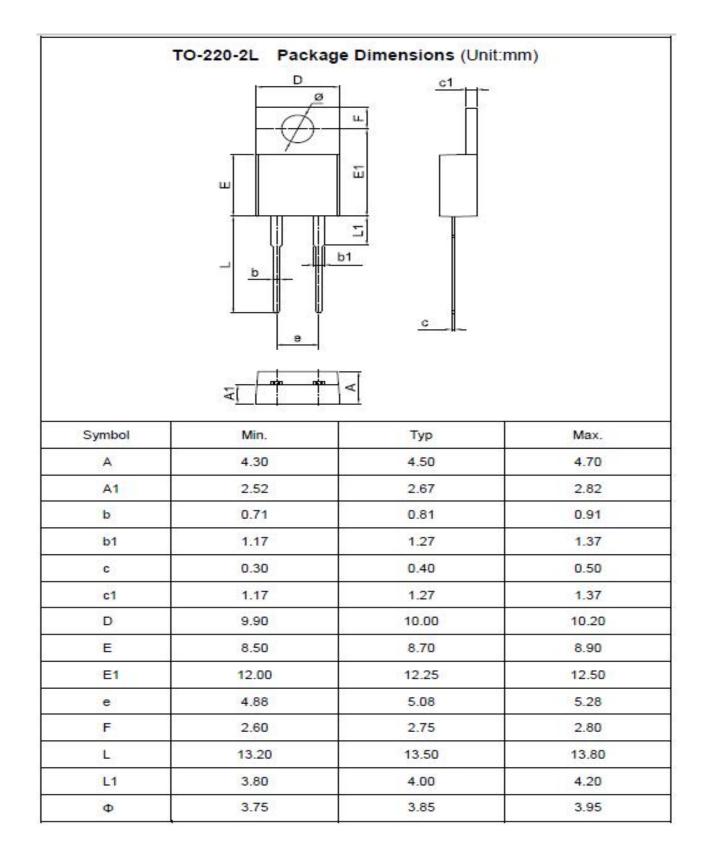


Typical Feature Curve





Package outline drawing(TO-220 Unit: mm)





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